AN11453
BGU7258 802.11 a/n/ac Low Noise Amplifier 5-6 GHz WiFi LNA MMIC with Bypass

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Application note

Document information

<table>
<thead>
<tr>
<th>Info</th>
<th>Content</th>
</tr>
</thead>
<tbody>
<tr>
<td>Keywords</td>
<td>BGU7258, 5-6GHz LNA, 5 GHz ISM, WiFi (WLAN)</td>
</tr>
<tr>
<td>Abstract</td>
<td>This document provides circuit schematic, layout, BOM and typical evaluation board performance for a 5-6 GHz WiFi (WLAN) LNA with bypass</td>
</tr>
</tbody>
</table>
1. Introduction

The BGU7258 is a fully integrated MMIC Low Noise Amplifier (LNA) for wireless receiver applications in the 5 GHz to 6 GHz ISM band. Manufactured in NXP’s high performance SiGe:C technology, the BGU7258 couples best-in-class gain, noise figure, linearity and efficiency with the process stability and ruggedness that are the hallmarks of SiGe technology. The BGU7258 features a robust temperature-compensated internal bias network and an integral bypass / shutdown feature that stabilizes the DC operating point over temperature and enables operation in the presence of high input signals, while minimizing current consumption in bypass (standby) mode. The 1.6 mm x 1.6 mm footprint coupled with only two external components, makes the circuit board implementation of the BGU7258 LNA the smallest IEEE 802.11ac LNA with bypass solution on the market, ideal for space sensitive applications.

Key Benefits:

- Fully integrated, high performance LNA with built-in bypass
- Exceptional 1.6 dB noise figure with 13 mA current consumption
- Extremely low bypass current (2 µA)
- Single supply 3.0 V to 3.6 V operation
- Integrated concurrent 2.4 GHz notch filter and temperature stabilized bias network
- High IIP3 and low EVM
- High ESD protection of 2 kV (HBM) on all pins
- Small 0.5 mm pitch, 1.6 x 1.6 x 0.5 mm QFN-style package, MSL 1 at 260°C
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS) following NXP’s RHF-2006 indicator D (dark green)

![BGU7258 Block Diagram](image)
2. Design and Application

The overall intent of this application note is to demonstrate the performance of the BGU7258 in a 5 GHz LNA application e.g. 802.11a/n/ac “MIMO” WiFi (WLAN). Key requirements for this type of WLAN application are gain, noise figure, linearity, input and output return loss, and turn on/off time.

The BGU7258 itself is a fully integrated MMIC consisting of an RF Gain block, internal temperature compensated bias network, bypass mode functionality, 2.4 GHz notch filter to suppress jammers from 2.4 GHz ISM Band, ESD protection, internal RF matching, and internal DC blocking. Only two external components, a 4.7 nF DC-decoupling capacitor on the power supply line and an optional shunt 0.3 pF capacitor for matching at RF input is necessary.

On NXP’s Application Board, the BGU7258 can be also used without the matching capacitor at the RF_IN, but in this case, the gain will decrease by ~0.5 dB and the noise figure increases by ~ 0.1 dB at 5.8 GHz.

The 5 GHz WiFi LNA evaluation board simplifies the evaluation of the BGU7258 application. The evaluation board enables testing of the device performance and requires no additional support circuitry. The board is fully assembled with the BGU7258 MMIC, and includes the 4.7 nF DC-decoupling capacitor and the 0.3 pF input matching capacitor. The board is also supplied with two SMA connectors for input and output connection to RF test equipment.

A 50 ohm “through line” is provided at the top of the evaluation board in case the user wishes to verify RF connector and grounded coplanar wave guide losses for de-embedding purposes.
Fig 2. BGU7258 Evaluation Board 5-6 GHz WiFi LNA EVB
2.1 Application Circuit Schematic

![BGU7258 Evaluation Board: Schematic](image)

**Note:** Figure 3 is the schematic for BGU7258 evaluation board with only two external components (Matching shunt capacitor on RF_IN and DC-decoupling capacitor, placed near the VCC pin).

*The BGU7258 can be also used without the matching capacitor at the RF_IN, but then the gain will be ~0.5 dB less and the noise figure increases ~0.1 dB at 5.8 GHz!*

2.2 PCB Layout

- Use controlled impedance lines (50 Ω) for RF_in & RF_out
- Place the decoupling capacitor as close as possible to the device pin 6 (Vcc)
- Proper grounding of the RF GND especially pin 7 (ground pad) is essential for good RF-performance. Connect the GND pins direct to ground plane and use through vias on ground pad (size and amount depends on the technology used)
2.3 Board Layout

**Fig 4. BGU7258 Evaluation Board**

**Fig 5. BGU7258 Stack of the PCB material**
## 2.4 Application Board Bill-Of-Material

### Table 1. BGU7258 5-6 GHz WiFi LNA Part List

Customer can choose their preferred vendor but should be aware that the performance could be affected. “0402” case size passives are used on NXP’s evaluation board.

<table>
<thead>
<tr>
<th>Item</th>
<th>Position on Layout</th>
<th>Reference (Fig 2)</th>
<th>Type</th>
<th>Vendor</th>
<th>Value</th>
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<tbody>
<tr>
<td>1</td>
<td>Z1</td>
<td>BGU7258</td>
<td>BGU7258</td>
<td>NXP SEMICONDUCTORS</td>
<td>BGU7258</td>
</tr>
<tr>
<td>2</td>
<td>Z2</td>
<td>C1</td>
<td>GRM155</td>
<td>Murata</td>
<td>4.7 nF</td>
</tr>
<tr>
<td>3</td>
<td>RF_IN</td>
<td>Shunt Capacitor</td>
<td>GJM155</td>
<td>Murata</td>
<td>0.3 pF</td>
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<tr>
<td>4</td>
<td>X1, X2</td>
<td>RF_IN, RF_OUT</td>
<td>Emerson Network Power</td>
<td>CON-SMA-1</td>
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<tr>
<td>5</td>
<td>X3</td>
<td>Vcc/LNA gain/bypass</td>
<td>Molex</td>
<td></td>
<td>CON-3PIN</td>
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</table>
3. Typical Application Board Test Result

This section presents the results of a typical BGU7258 as used in NXP’s Application Circuit. Unless otherwise noted, all measurement references are at the SMA connectors on the evaluation board.

3.1.1 S-Parameters

Figures 6 and 7 below show the broadband (10 MHz – 10 GHz) and narrowband s-parameters for the BGU7258 respectively. Figure 8 shows the measured stability factor from 1 GHz – 20 GHz.

![Fig 6. BGU7258 Broadband S-Parameters V<sub>CC</sub> = 3.3V 25°C ambient](image-url)
Fig 7. BGU7258 Narrowband S-Parameters  V_{CC} = 3.3V  25°C ambient
Fig 8. BGU7258 Broadband K Factor (Rollett Stability Factor) $V_{CC} = 3.3\text{V}$  25°C ambient
3.1.2 S-Parameters in Bypass mode

Figure 9 and 10 below shows the gain, input return loss, and output return loss of the BGU7258 in bypass mode.
Fig 10.  BGU7258 Narrowband S-Parameters  Bypass Mode  Vcc = 3.3V  25°C ambient
### 3.1.3 Noise Figure in Gain mode

The noise figure is physically measured at the SMA connectors of the evaluation board. The total loss of the connectors and the printed circuit board are 0.5dB at 5.5 GHz (RF_IN to RF_OUT). After de-embedding the input portion of connector and PCB losses (0.25dB at 5.5 GHz) to the device pins, the noise figure is around 1.6dB at 5.5 GHz. Figure 11 below shows both the noise figure at the EVB level and the de-embedded noise figure.

![Graph showing noise figure in Gain mode](image-url)
3.1.4 Small Signal Linearity in Gain mode

Figure 12 shows the input-referred IP3 level for the BGU7258, measured with 5 MHz tone spacing, -25 dBm input power per tone, and a swept center frequency from 5 GHz to 6 GHz.

Fig 12. BGU7258 Swept input-IP3 5MHz Tone Spacing Pin=-25dBm/Tone  V<sub>CC</sub> = 3.3V  25°C ambient
3.1.5 Large Signal Linearity in Gain mode

Figure 13 shows the input referred P1dB level from 5 GHz to 6 GHz.

![Graph showing input referred P1dB level from 5 GHz to 6 GHz](image)

**Fig 13.** BGU7258 input-P1dB vs. frequency  \( V_{CC} = 3.3V \)  25°C ambient
Figure 14 shows Error Vector Magnitude (EVM) as a function of output power, with BGU7258 in Gain mode. Specifically, these data are captured using a 256 QAM OFDM waveform MSC9-VHT40. Note that the output power is the average power over the burst.

![Graph showing EVM vs. Output Power for BGU7258 at 5190 MHz and 5795 MHz]

EVM (%) vs. Output Power (dBm)

**Fig 14.** BGU7258  EVM vs. burst average output power  MCS9-VHT40  256 QAM $V_{CC} = 3.3V$  25°C ambient
3.1.6 Out-of-band spurious

In order to characterize the BGU7258 under potential jamming conditions, a 5.180 GHz signal is applied to the evaluation board at an RF input power level of -30 dBm. A second tone is applied at 2.462 GHz and swept over a range of input power levels. The 2.462 GHz “leakage” and the second harmonic at 4.924 GHz are measured. The measurement set-up is shown in Figure 15. As a function of the 2.462 GHz jammer input level, Figure 16 reports the 2.462 GHz jammer output level, the 4.924 GHz second harmonics output level, and the 5.180 GHz Gain.

![Fig 15. Out-of-band suppression test setup (if necessary use additional low pass filter at signal generator 2 output)](image-url)
Fig 16. BGU7258 2462 MHz Jammer Level at Output, 4924 MHz second harmonics and 5180 MHz Gain vs. Jammer Input Power. $V_{CC} = 3.3V$, 25°C ambient, 5180 MHz input at -30 dBm.
3.1.7 Harmonics

By applying large RF signals at the input during bypass mode (OFF mode) operation, harmonics can be created by the LNA and then emanate from its RF input. In a real operating environment, these harmonic signals can be re-emitted by the antenna. The measurement set up used for characterizing the harmonics generated by the BGU7258 in bypass mode is shown in Figure 17. A 5.500 GHz signal is used for the measurement results shown in Figure 18.

![Harmonic test setup](image-url)
(1) CW – Continuous Wave (only for test / comparison)
(2) WFM1 - 802.11a  6 Mbps (BPSK) 90% duty cycle (worst case signal)

Fig 18. BGU7258 (Bypass Mode) 2\textsuperscript{nd} and 3\textsuperscript{rd} Reflected Harmonic Levels 5.5 GHz Fundamental
### 3.1.8 LNA Turn ON-OFF Time

The following diagram shows the setup to test LNA Turn ON and Turn OFF time.

The waveform generator is set to square wave mode and the output amplitude at 3.3V peak with 50Ω output impedance. The RF signal generator output level is -20dBm at 5.5 GHz. It is very important to minimize or compensate for the time delay skew between the trigger signal and the detector signal. Also note that the scope input impedances are set to 50Ω on both channels.

![Fig 19. LNA Turn On and Turn Off time test setup](image-url)
3.1.8.1 LNA Turn ON Time

Figure 20 below shows a screen capture from an oscilloscope used to record the turn on time of the BGU7258.

100Hz 0/3V Square Wave, applied on Venable pin, measured from 50% of input pulse to 90% of maximum output power

Fig 20. BGU7258 Turn On Time
3.1.8.2 LNA Turn OFF Time

Figure 21 below shows an oscilloscope screen capture with the turn off time for the BGU7258.

100Hz 0/3.3V Square Wave, applied on Venable pin, measured from 50% of input pulse to 10% of maximum output power

Fig 21. BGU7258 Turn Off Time
### 4. Summary of the Typical Evaluation Board Test Result

**Table 2. Typical results measured on the BGU7258 5-6 GHz WiFi LNA Evaluation Board with 0.3 pF matching capacitor at the RF_IN**

*Operating frequency 4.9-5.925 GHz, testing at 5.1 GHz and 5.9 GHz in Gain mode unless otherwise specified, Temp = 25°C. Unless noted, all measurements are done with SMA-connectors as reference plane.*

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Value</th>
<th>Unit</th>
</tr>
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<tr>
<td>Supply Voltage</td>
<td>Vcc</td>
<td>3.3</td>
<td>V</td>
</tr>
<tr>
<td>Supply Current</td>
<td>Icc</td>
<td>12.5</td>
<td>mA</td>
</tr>
<tr>
<td>ByPass Current</td>
<td>Ibypass</td>
<td>1.0</td>
<td>μA</td>
</tr>
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<td>Noise Figure [1]</td>
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</tr>
<tr>
<td>@ 5.1 GHz</td>
<td>NF</td>
<td>1.6</td>
<td>dB</td>
</tr>
<tr>
<td>@ 5.9 GHz</td>
<td>NF</td>
<td>1.7</td>
<td>dB</td>
</tr>
<tr>
<td>Power Gain</td>
<td>@ 5.1 GHz</td>
<td>13.8</td>
<td>dB</td>
</tr>
<tr>
<td>@ 5.9 GHz</td>
<td>Gp</td>
<td>12.7</td>
<td>dB</td>
</tr>
<tr>
<td>Input Return Loss</td>
<td>@ 5.1 GHz</td>
<td>12.5</td>
<td>dB</td>
</tr>
<tr>
<td>@ 5.9 GHz</td>
<td>IRL</td>
<td>23.0</td>
<td>dB</td>
</tr>
<tr>
<td>Output Return Loss</td>
<td>@ 5.1 GHz</td>
<td>20.0</td>
<td>dB</td>
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<tr>
<td>@ 5.9 GHz</td>
<td>ORL</td>
<td>16.0</td>
<td>dB</td>
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<tr>
<td>Reverse Isolation</td>
<td>@ 5.1 GHz</td>
<td>-21.0</td>
<td>dB</td>
</tr>
<tr>
<td>@ 5.9 GHz</td>
<td>ISLrev</td>
<td>-20.0</td>
<td>dB</td>
</tr>
<tr>
<td>Power Gain (bypass mode)</td>
<td>@ 5.1 GHz</td>
<td>-7.7</td>
<td>dB</td>
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<tr>
<td>@ 5.9 GHz</td>
<td>Gp</td>
<td>-7.6</td>
<td>dB</td>
</tr>
<tr>
<td>Input Return Loss (bypass mode)</td>
<td>@ 5.1 GHz</td>
<td>9.0</td>
<td>dB</td>
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<tr>
<td>@ 5.9 GHz</td>
<td>IRL</td>
<td>10.0</td>
<td>dB</td>
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<tr>
<td>Output Return Loss (bypass mode)</td>
<td>@ 5.1 GHz</td>
<td>21.0</td>
<td>dB</td>
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<tr>
<td>@ 5.9 GHz</td>
<td>ORL</td>
<td>16.0</td>
<td>dB</td>
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<td>Input Third Order Intercept Point Two Tones:</td>
<td>@ 5.1 GHz</td>
<td>26.7</td>
<td>dBm</td>
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<tr>
<td>5 MHz Tone Spacing Power: -5 dBm/tone (bypass mode)</td>
<td>@ 5.9 GHz</td>
<td>28.1</td>
<td>dBm</td>
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<td>Output Third Order Intercept Point Two Tones:</td>
<td>@ 5.1 GHz</td>
<td>19.0</td>
<td>dBm</td>
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<tr>
<td>5 MHz Tone Spacing Power: -5 dBm/tone (bypass mode)</td>
<td>@ 5.9 GHz</td>
<td>20.5</td>
<td>dBm</td>
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<tr>
<td>Input 1dB Gain Compression Point</td>
<td>@ 5.1 GHz</td>
<td>-4.7</td>
<td>dBm</td>
</tr>
<tr>
<td>@ 5.9 GHz</td>
<td>iP1dB</td>
<td>-4.0</td>
<td>dBm</td>
</tr>
<tr>
<td>Output 1dB Gain Compression Point</td>
<td>@ 5.1 GHz</td>
<td>8.1</td>
<td>dBm</td>
</tr>
<tr>
<td>@ 5.9 GHz</td>
<td>oP1dB</td>
<td>7.7</td>
<td>dBm</td>
</tr>
<tr>
<td>Error Vector Magnitude</td>
<td>@ 5.1 GHz</td>
<td>2.2</td>
<td>%</td>
</tr>
<tr>
<td>Pout = 0 dBm (256 QAM, MSC9-VHT-40)</td>
<td>@ 5.9 GHz</td>
<td>2.3</td>
<td>%</td>
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</table>
Parameter | Symbol | Value | Unit |
---|---|---|---|
Input Third Order Intercept Point Two Tones: 5 MHz Tone Spacing power: -25 dBm/tone @ 5.1 GHz | IIP3 | 7.9 | dBm |
@ 5.9 GHz | IIP3 | 8.6 | dBm |
Output Third Order Intercept Point Two Tones: 5 MHz Tone Spacing power: -25 dBm/tone @ 5.1 GHz | OIP3 | 21.5 | dBm |
@ 5.9 GHz | OIP3 | 21.2 | dBm |
1 dB input/output cross-compression with jammer @ 5180 MHz with 2462 MHz Jammer | | -1.0 | dBm |
Harmonics generated at RF input Pin = 4 dBm (5.5 GHz) 2.H. @ 11.0 GHz | H2 | -50 | dBm |
CW signal input (bypass mode) 3.H. @ 16.5 GHz | H3 | < -90 | dBm |
Stability (1 - 20 GHz) | K | > 1 |
LNA Turn ON/OFF Time | Ton | 100 | nS |
| Toff | 19 | nS |

[1] PCB and connector losses excluded.
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6. List of figures

Fig 1.  BGU7258 Block Diagram...............................3
Fig 2.  BGU7258 Evaluation Board  5-6 GHz WiFi LNA EVB.........................................................5
Fig 3.  BGU7258 Evaluation Board: Schematic ..........6
Fig 4.  BGU7258 Evaluation Board..........................7
Fig 5.  BGU7258 Stack of the PCB material..............7
Fig 6.  BGU7258 Broadband S-Parameters $V_{CC} =$ 3.3V  25°C ambient........................................9
Fig 7.  BGU7258 Narrowband S-Parameters $V_{CC} =$ 3.3V  25°C ambient..........................................10
Fig 8.  BGU7258 Broadband K Factor (Rollett Stability Factor) $V_{CC} = 3.3V$  25°C ambient..............11
Fig 9.  BGU7258 Broadband S-Parameters Bypass Mode $V_{cc} = 3.3V$  25°C ambient.................12
Fig 10. BGU7258 Narrowband S-Parameters Bypass Mode $V_{cc} = 3.3V$  25°C ambient.............13
Fig 11. BGU7258 Noise Figure $V_{CC} = 3.3V$  25°C ambient......................................................14
Fig 12. BGU7258 Swept input-IP3 5MHz Tone Spacing Pin=-25dBm/Tone $V_{CC} = 3.3V$  25°C ambient15
Fig 13. BGU7258 input-P1dB vs. frequency $V_{CC} =$ 3.3V  25°C ambient.................................16
Fig 14. BGU7258 EVM vs. burst average output power MCS9-VHT40 256 QAM $V_{CC} = 3.3V$  25°C ambient..............................17
Fig 15. Out-of-band suppression test setup (if necessary use additional low pass filter at signal generator 2 output) ..................................................18
Fig 16. BGU7258 2462 MHz Jammer Level at Output, 4924 MHz second harmonics and 5180 MHz Gain vs. Jammer Input Power $V_{CC} = 3.3V$  25°C ambient 5180 MHz input at -30 dBm .......................................................19
Fig 17. Harmonic test setup..................................20
Fig 18. BGU7258 (Bypass Mode) 2nd and 3rd Reflected Harmonic Levels 5.5 GHz Fundamental......21
Fig 19. LNA Turn On and Turn Off time test setup.....22
Fig 20. BGU7258 Turn On Time...............................23
Fig 21. BGU7258 Turn Off Time..............................24
## 7. List of tables

<table>
<thead>
<tr>
<th>Table</th>
<th>Description</th>
<th>Page</th>
</tr>
</thead>
<tbody>
<tr>
<td>Table 1</td>
<td>BGU7258 5-6 GHz WiFi LNA Part List</td>
<td>8</td>
</tr>
<tr>
<td>Table 2</td>
<td>Typical results measured on the BGU7258 5-6 GHz WiFi LNA Evaluation Board with 0.3 pF matching capacitor at the RF_IN</td>
<td>25</td>
</tr>
</tbody>
</table>
8. Contents

1. Introduction ......................................................... 3
2. Design and Application....................................... 4
  2.1 Application Circuit Schematic ............................. 6
  2.2 PCB Layout........................................................ 6
  2.3 Board Layout...................................................... 7
  2.4 Application Board Bill-Of-Material ........................ 8
3. Typical Application Board Test Result .................. 9
  3.1.1 S-Parameters ..................................................... 9
  3.1.2 S-Parameters in Bypass mode ........................... 12
  3.1.3 Noise Figure in Gain mode .............................. 14
  3.1.4 Small Signal Linearity in Gain mode ............... 15
  3.1.5 Large Signal Linearity in Gain mode ............... 16
  3.1.6 Out-of-band spurious ..................................... 18
  3.1.7 Harmonics ........................................................ 20
  3.1.8 LNA Turn ON-OFF Time .................................. 22
  3.1.8.1 LNA Turn ON Time ........................................ 23
  3.1.8.2 LNA Turn OFF Time ...................................... 24
4. Summary of the Typical Evaluation Board Test Result ........................................ 25
5. Legal information .............................................. 27
  5.1 Definitions ........................................................ 27
  5.2 Disclaimers....................................................... 27
  5.3 Licenses ............................................................. 27
  5.4 Patents ............................................................. 27
  5.5 Trademarks ........................................................ 27
6. List of figures..................................................... 28
7. List of tables ...................................................... 29
8. Contents.................................................................. 30